

FX6ASJ-3

High-Speed Switching Use Pch Power MOS FET

REJ03G1439-0200

(Previous: MEJ02G0287-0101)

Rev.2.00 Aug 07, 2006

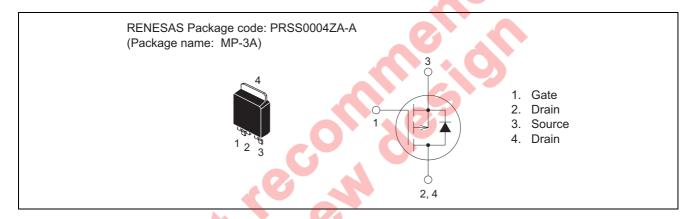
Features

 $\begin{array}{ll} \bullet & Drive\ voltage: 4\ V \\ \bullet & V_{DSS}: -150\ V \\ \bullet & r_{DS(ON)\ (max)}: 0.53\ \Omega \end{array}$

• $I_D: -6 A$

• Integrated Fast Recovery Diode (TYP.): 100 ns

Outline



Applications

Motor control, Lamp control, Solenoid control, DC-DC converters, etc.

Maximum Ratings

 $(Tc = 25^{\circ}C)$

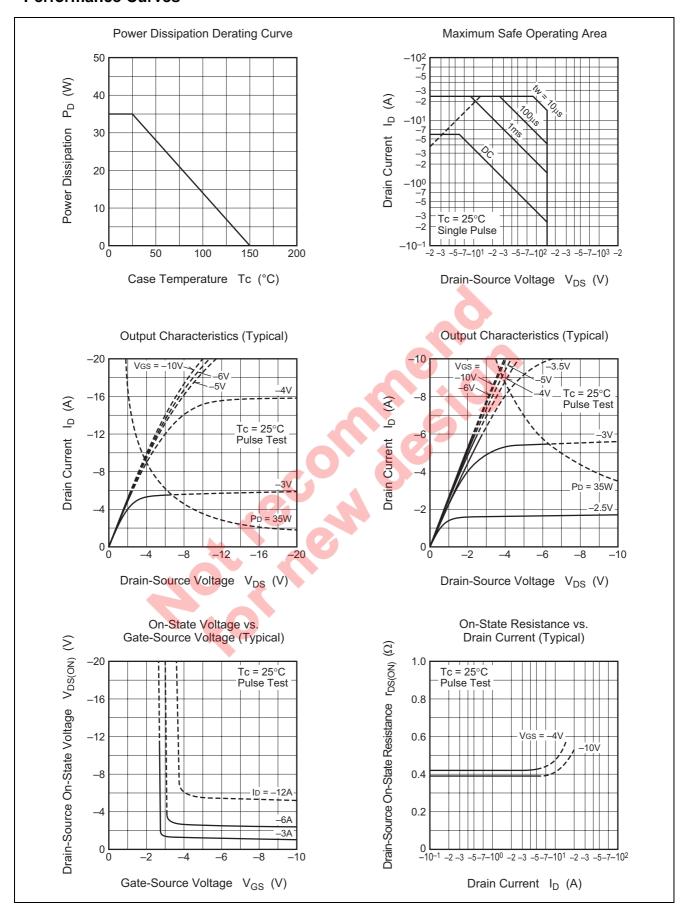
Parameter	Symbol	Ratings	Unit	Conditions
Drain-source voltage	V _{DSS}	-150	V	V _{GS} = 0 V
Gate-source voltage	V_{GSS}	±20	V	$V_{DS} = 0 V$
Drain current	I _D	-6	А	
Drain current (Pulsed)	I _{DM}	-24	А	
Avalanche drain current (Pulsed)	I _{DA}	-6	А	L = 100 μH
Source current	Is	-6	А	
Source current (Pulsed)	I _{SM}	-24	А	
Maximum power dissipation	P_D	35	W	
Channel temperature	Tch	- 55 to +150	°C	
Storage temperature	Tstg	- 55 to +150	°C	
Mass	-	0.32	g	Typical value

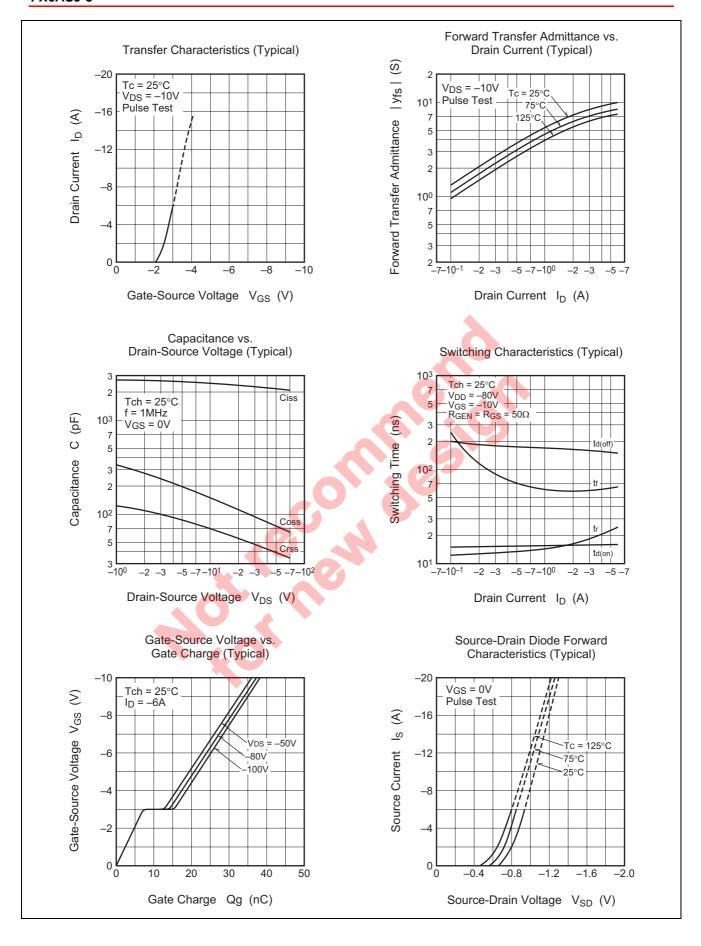
Electrical Characteristics

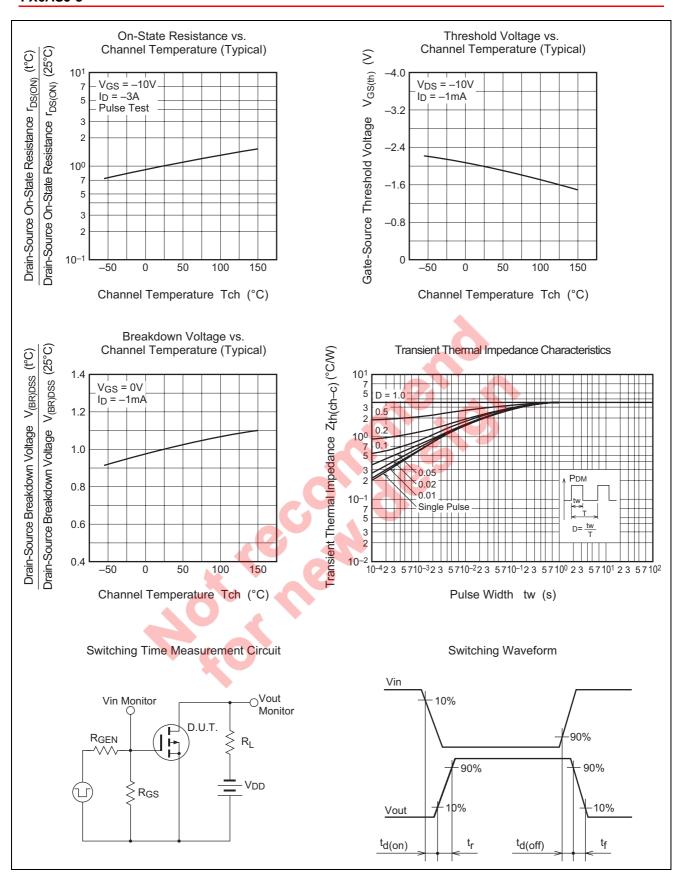
 $(Tch = 25^{\circ}C)$

Drain-source breakdown voltage V(BR)DSS −150 − Gate-source leakage current I _{GSS} − − Drain-source leakage current I _{DSS} − − Gate-source threshold voltage V _{GS(th)} −1.3 −1.8 Drain-source on-state resistance r _{DS(ON)} − 0.41 Drain-source on-state resistance r _{DS(ON)} − 0.45 Drain-source on-state voltage V _{DS(ON)} − −1.23 Forward transfer admittance y _{fs} − − 7.9 Input capacitance Ciss − 2420 Output capacitance Coss − 152 Reverse transfer capacitance Crss − 69 Turn-on delay time t _{d(on)} − 14 Rise time t _f − 18 Turn-off delay time t _f − 156 Fall time t _f − 58 Source-drain voltage V _{SD} − − Thermal resistance R _{th(ch-c)} − − Reverse recovery time	- -0.1 -1.8 -2.3 0.41 0.53 0.45 0.59 -1.23 -1.59 7.9 - 2420 - 152 - 69 - 14 - 18 - 156 - 58 -	V μA mA V Ω Ω V S pF pF ns ns ns ns	$\begin{split} I_D &= -1 \text{ mA}, V_{GS} = 0 \text{ V} \\ V_{GS} &= \pm 20 \text{ V}, V_{DS} = 0 \text{ V} \\ V_{DS} &= -150 \text{ V}, V_{GS} = 0 \text{ V} \\ I_D &= -1 \text{ mA}, V_{DS} = -10 \text{ V} \\ I_D &= -3 \text{ A}, V_{GS} = -10 \text{ V} \\ I_D &= -3 \text{ A}, V_{GS} = -4 \text{ V} \\ I_D &= -3 \text{ A}, V_{GS} = -10 \text{ V} \\ I_D &= -3 \text{ A}, V_{DS} = -10 \text{ V} \\ V_{DS} &= -10 \text{ V}, V_{GS} = 0 \text{ V}, \\ f &= 1 \text{MHz} \\ \end{split}$ $V_{DD} &= -80 \text{ V}, I_D = -3 \text{ A}, \\ V_{GS} &= -10 \text{ V}, \\ R_{GEN} &= R_{GS} = 50 \Omega \\ \end{split}$			
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	- -0.1 -1.8 -2.3 0.41 0.53 0.45 0.59 -1.23 -1.59 7.9 - 2420 - 152 - 69 - 14 - 18 - 156 - 58 -	mA V Ω Ω V S pF pF ns ns ns	$\begin{split} V_{DS} &= -150 \text{ V}, \ V_{GS} = 0 \text{ V} \\ I_D &= -1 \text{ mA}, \ V_{DS} = -10 \text{ V} \\ I_D &= -3 \text{ A}, \ V_{GS} = -10 \text{ V} \\ I_D &= -3 \text{ A}, \ V_{GS} = -4 \text{ V} \\ I_D &= -3 \text{ A}, \ V_{GS} = -10 \text{ V} \\ I_D &= -3 \text{ A}, \ V_{DS} = -10 \text{ V} \\ V_{DS} &= -10 \text{ V}, \ V_{GS} = 0 \text{ V}, \\ f &= 1 \text{MHz} \\ \\ V_{DD} &= -80 \text{ V}, \ I_D = -3 \text{ A}, \\ V_{GS} &= -10 \text{ V}, \\ R_{GEN} &= R_{GS} = 50 \Omega \end{split}$			
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	-1.8 -2.3 0.41 0.53 0.45 0.59 -1.23 -1.59 7.9 - 2420 - 152 - 69 - 14 - 18 - 156 - 58 -	V Ω Ω V S pF pF pF ns ns ns	$\begin{split} I_D &= -1 \text{ mA}, V_{DS} = -10 \text{ V} \\ I_D &= -3 \text{ A}, V_{GS} = -10 \text{ V} \\ I_D &= -3 \text{ A}, V_{GS} = -4 \text{ V} \\ I_D &= -3 \text{ A}, V_{GS} = -10 \text{ V} \\ I_D &= -3 \text{ A}, V_{DS} = -10 \text{ V} \\ V_{DS} &= -10 \text{ V}, V_{GS} = 0 \text{ V}, \\ f &= 1 \text{MHz} \\ \\ V_{DD} &= -80 \text{ V}, I_D = -3 \text{ A}, \\ V_{GS} &= -10 \text{ V}, \\ R_{GEN} &= R_{GS} = 50 \Omega \end{split}$			
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	0.41 0.53 0.45 0.59 -1.23 -1.59 7.9 — 2420 — 152 — 69 — 14 — 18 — 156 — 58 —	Ω Ω V S pF pF pF ns ns ns	$\begin{split} I_D &= -3 \text{ A, } V_{GS} = -10 \text{ V} \\ I_D &= -3 \text{ A, } V_{GS} = -4 \text{ V} \\ I_D &= -3 \text{ A, } V_{GS} = -10 \text{ V} \\ I_D &= -3 \text{ A, } V_{DS} = -10 \text{ V} \\ V_{DS} &= -10 \text{ V, } V_{GS} = 0 \text{ V, } \\ f &= 1 \text{MHz} \\ \\ V_{DD} &= -80 \text{ V, } I_D = -3 \text{ A, } \\ V_{GS} &= -10 \text{ V, } \\ R_{GEN} &= R_{GS} = 50 \Omega \end{split}$			
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	0.45 0.59 -1.23 -1.59 7.9 — 2420 — 152 — 69 — 14 — 18 — 156 — 58 —	Ω V S pF pF pF ns ns ns	$\begin{split} I_D &= -3 \text{ A, } V_{GS} = -4 \text{ V} \\ I_D &= -3 \text{ A, } V_{GS} = -10 \text{ V} \\ I_D &= -3 \text{ A, } V_{DS} = -10 \text{ V} \\ V_{DS} &= -10 \text{ V, } V_{GS} = 0 \text{ V, } \\ f &= 1 \text{MHz} \\ \\ V_{DD} &= -80 \text{ V, } I_D = -3 \text{ A, } \\ V_{GS} &= -10 \text{ V, } \\ R_{GEN} &= R_{GS} = 50 \Omega \end{split}$			
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	-1.23 -1.59 7.9 — 2420 — 152 — 69 — 14 — 18 — 156 — 58 —	V S pF pF pF ns ns	$\begin{split} I_D &= -3 \text{ A, } V_{GS} = -10 \text{ V} \\ I_D &= -3 \text{ A, } V_{DS} = -10 \text{ V} \\ V_{DS} &= -10 \text{ V, } V_{GS} = 0 \text{ V, } \\ f &= 1 \text{MHz} \\ \\ V_{DD} &= -80 \text{ V, } I_D = -3 \text{ A, } \\ V_{GS} &= -10 \text{ V, } \\ R_{GEN} &= R_{GS} = 50 \Omega \end{split}$			
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	7.9 — — — — — — — — — — — — — — — — — — —	S pF pF pF ns ns ns	$\begin{split} I_D &= -3 \text{ A, } V_{DS} = -10 \text{ V} \\ V_{DS} &= -10 \text{ V, } V_{GS} = 0 \text{ V, } \\ f &= 1 \text{MHz} \end{split}$ $V_{DD} &= -80 \text{ V, } I_D = -3 \text{ A, } \\ V_{GS} &= -10 \text{ V, } \\ R_{GEN} &= R_{GS} = 50 \Omega \end{split}$			
Input capacitance Ciss — 2420 Output capacitance Coss — 152 Reverse transfer capacitance Crss — 69 Turn-on delay time t _{d(on)} — 14 Rise time t _r — 18 Turn-off delay time t _{d(off)} — 156 Fall time t _f — 58 Source-drain voltage V _{SD} — -1.0	2420 — 152 — 69 — 14 — 18 — 156 — 58 —	pF pF pF ns ns ns	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V},$ $f = 1 \text{MHz}$ $V_{DD} = -80 \text{ V}, I_{D} = -3 \text{ A},$ $V_{GS} = -10 \text{ V},$ $R_{GEN} = R_{GS} = 50 \Omega$			
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	152 — 69 — 14 — 18 — 156 — 58 —	pF pF ns ns ns	$f = 1 MHz$ $V_{DD} = -80 \text{ V}, I_D = -3 \text{ A},$ $V_{GS} = -10 \text{ V},$ $R_{GEN} = R_{GS} = 50 \Omega$			
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	69 — 14 — 18 — 156 — 58 —	pF ns ns	$V_{DD} = -80 \text{ V}, I_{D} = -3 \text{ A},$ $V_{GS} = -10 \text{ V},$ $R_{GEN} = R_{GS} = 50 \Omega$			
	14 — 18 — 156 — 58 —	ns ns ns	$V_{GS} = -10 \text{ V},$ $R_{GEN} = R_{GS} = 50 \Omega$			
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	18 — 156 — 58 —	ns ns ns	$V_{GS} = -10 \text{ V},$ $R_{GEN} = R_{GS} = 50 \Omega$			
$ \begin{array}{c cccc} Turn\text{-off delay time} & & t_{d(off)} & - & 156 \\ \hline Fall time & & t_f & - & 58 \\ \hline Source\text{-drain voltage} & & V_{SD} & - & -1.0 \\ \hline \end{array} $	156 — 58 —	ns ns	$R_{GEN} = R_{GS} = 50 \Omega$			
	58 —	ns				
Source-drain voltage V _{SD} — -1.0			I _S = -3 A, V _{GS} = 0 V			
	-1.0 -1.5	V	$I_S = -3 \text{ A}, V_{GS} = 0 \text{ V}$			
Thermal resistance R _{th(ch-c)} — — — Reverse recovery time t _{rr} — 100						
Reverse recovery time t _{rr} — 100	— 3.57	°C/W	Channel to case			
	100	ns	$I_S = -6 \text{ A}, d_{is}/d_t = 100 \text{ A}/\mu\text{s}$			
Thermal resistance R _{th(ch-c)} — — — 3.57 °C/W Channel to case Reverse recovery time t _{rr} — 100 — ns t _s = -6 A, d _{ts} /d _t = 100 A/μs						

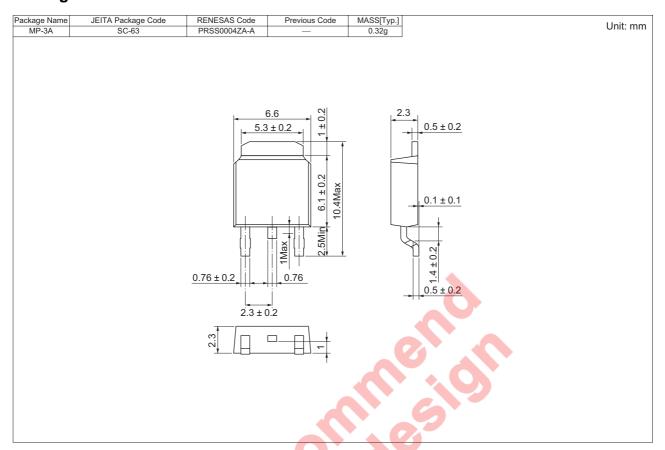
Performance Curves







Package Dimensions



Order Code

Lead form	Standard packing	Quantity	Standard order code	Standard order code example
Surface-mounted type	Taping	3000	Type name – T +Direction (1 or 2) +3	FX6ASJ-3-T13
Surface-mounted type	Plastic Magazine (Tube)	75	Type name	FX6ASJ-3

Note: Please confirm the specification about the shipping in detail.

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